



For Immediate Release

Photo Stencil Introduces Process Pallet Product Line

COLORADO SPRINGS, Colorado – September 24, 2007 – Photo Stencil, the leading provider of high-performance stencils and tooling for the SMT assembly industry, is introducing a new process pallet product line with centralized order processing and manufacturing. All design, assembly and quality assurance is performed at the company's worldwide headquarters in Colorado Springs, Colorado. The centralized pallet logistics and synergistic relationship with their stencil product line provide customers the opportunity to procure all assembly tooling from a single source using existing data from the Gerber files.

In addition to centralized pallet production, Photo Stencil has revamped the product line to include ESD-safe process carriers for wave solder and SMT assembly. The carriers, ideal for use with lead-free solder, allow masking of specific areas so that only the parts that need to be soldered are affected. In addition, boards and components are protected from thermal shock and ESD. These process pallets can provide increased productivity, quality and reliability, and lessen the need to touch up and/or replace components. The new pallet line utilizes materials ideally suited to the soldering process, including Durapol and, for higher production temperatures, Delmat.

Under the leadership of Jim Petrain, pallet product manager, Photo Stencil offers in-house design capabilities backed by more than 20 years of practical, hands-on wave soldering experience.

"We can anticipate and solve complex design issues prior to manufacturing. This ensures high performance wave solder pallets and process carriers that maximize first-pass yields, even in lead-free and fine-pitch SMT environments," explains Petrain. "We design pallets and carriers with 3D modeling and utilize high capacity CNC equipment to ensure flexibility and accuracy in machining base materials. By working closely with our customers, we are in a great position to

provide high quality products that complement our current lines and offer one-stop shopping for a variety of assembly needs.”

For more information, contact Mike Burgess, vice president of Photo Stencil, at 719-535-8539 (mburgess@photostencil.com) or visit www.photostencil.com.

###

About Photo Stencil

Photo Stencil is a leading full-service provider of high-performance stencils and tooling for the surface mount technology (SMT) assembly industry. Their innovations include the patented AMTX E-FAB[®] electroformed stencils, the high-performance, proprietary NicAlloy[™] stencil, laser-cut stencils and chem-etch stencils. Step or multi-level stencils are offered in all three technologies. Stencil design support and customer-specific design libraries are also provided.

Also offered is Photo Stencil's complete line of squeegee blades, featuring the patented, electroformed E-Blade[®]. Tooling products, including thick film and metal mask screens, solder pallets, SMT process carriers and populated PCB inspection templates round out their comprehensive portfolio of related products.

Headquartered in Colorado Springs, Photo Stencil was founded in 1979 and currently holds many patents, trademarks, and proprietary technologies. The company has additional manufacturing facilities in Mexico and Malaysia. Additional information is available at www.photostencil.com.

AMTX E-FAB, E-Blade and NicAlloy are trademarks of Photo Stencil.

Photo Stencil Contact:

Mike Burgess, Vice President
mburgess@photostencil.com
719-535-8539

Media Contact:

Bob Schreitmueller
Apogee Business Consulting, LLC
bob@ReachApogee.com